

# Performance limitations and analysis of silicon heterojunction solar cells using very thin MoO<sub>x</sub> hole-selective contacts

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**Abstract** — We recently showed that silicon heterojunction solar cell with MoO<sub>x</sub>-based hole-selective contact could reach 23.5% in efficiency with MoO<sub>x</sub> layers of 4 nm. Such thin MoO<sub>x</sub> layer enables a considerable current-density gain of over 1 mA/cm<sup>2</sup> compared to the use of p-type amorphous silicon, and outperforms thicker MoO<sub>x</sub> layers. In this study, we investigated the impact of the MoO<sub>x</sub> hole-selective layer for thickness between 0 and 4 nm. Based on opto-electrical characterization of the device at various processing stage, we discuss the optical and electrical effects of such variation on the solar-cell performances. We notably identify a loss of passivation and selectivity for MoO<sub>x</sub> films thinner than 4 nm, that we link to a reduced work-function for such thin MoO<sub>x</sub> films. We confirm experimentally that the optimal MoO<sub>x</sub> thickness is around 4 nm, yet evidence that close to 0.5 mA/cm<sup>2</sup> is still parasitically absorbed in such a thin layer.

**Index Terms**— Solar cells, silicon heterojunction, metal-oxides, molybdenum oxide, selectivity, passivation, passivating contact.

## I. INTRODUCTION

SILICON heterojunctions (SHJ) solar cells using hydrogenated-amorphous-silicon (a-Si:H) passivating contacts are known for simple processing combined with high efficiencies [1], [2]. Yet, their performances are hindered by parasitic absorption in the a-Si:H layers, with current losses up to 2.8 mA/cm<sup>2</sup> from p-type (p)a-Si:H and 1.9 mA/cm<sup>2</sup> from intrinsic (i)a-Si:H [3]–[5]. In the pursuit of current-loss mitigation, many wide-bandgap silicon-based materials such as (n)μc-Si (micro-crystalline Si) [6], (n)nc-SiO<sub>x</sub>:H (nano-crystalline SiO<sub>x</sub>) or (p)μc-SiO<sub>x</sub>:H [7][8], SiO<sub>x</sub>/(p)μc-Si [9], SiO<sub>x</sub>/(n)μc-Si:C [10] or (p)nc-Si:H/(p)nc-SiO<sub>x</sub>:H [11] stacks have been developed to replace a-Si:H. New Si-free materials are promising alternatives to Si-based contacts, due to the wide amount of available compounds and unlimited tunable properties to investigate. Integrated in solar cells, they have already proved high performances, like with PEDOT:PSS

[12][13], TiN<sub>x</sub> [14], b-PEI/Al [15], TiO<sub>x</sub>/LiF<sub>x</sub>/Al [16], ZnO/LiF<sub>x</sub>/Al [17] or MgF<sub>x</sub>/Mg/Al [18], mostly used as rear contact, and WO<sub>3</sub>, V<sub>2</sub>O<sub>5</sub> [19] or NiOx [20], [21] to replace front hole contact. Si-free contacts replacing both holes and electron contacts with different architectures, such as bifacial [22] or interdigitated back contacted (IBC) [18] solar cells, have also been developed.

Sub-stoichiometric molybdenum trioxide (MoO<sub>x</sub>) stands so far as the most successful non-silicon-based approach to replace the p-doped hydrogenated amorphous silicon (p)a-Si:H front hole selective layer (see Fig. 1) [18], [23]–[26]. In a previous work [26], we demonstrated that thinning down the MoO<sub>x</sub> front hole selective layer from 9 nm to 4 nm (in this work, all thicknesses are given on textured surfaces, calculated from measurements on flat Si or glass divided by a ratio of 1.6 accounting for the pyramids geometry [27]) significantly improved photocurrent while maintaining excellent hole-selectivity and front surface passivation, enabling high operating voltages. As a result, we demonstrated a 23.5% efficient 4-nm-MoO<sub>x</sub>-based heterojunction solar cell, notably thanks to a photocurrent 1.3 mA.cm<sup>-2</sup> higher than the reference

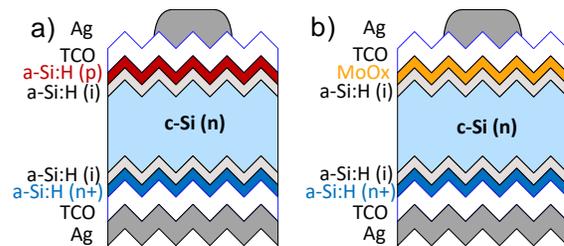


Fig. 1. Scheme of a silicon heterojunction solar cell, with a hole contact a) based on a-Si:H (standard), and b) MoO<sub>x</sub>-based

device using (p)a-Si:H as hole selective layer. However, the best efficiency of the series was obtained for the thinnest tested layer, intimating that the optimum may not be reached yet.

Extrapolating the current-density trends observed between 9-nm- and 4-nm-thick MoO<sub>x</sub> films to a 1-nm-thick MoO<sub>x</sub> layer

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suggested a possible current density gain of another 0.75 mA/cm<sup>2</sup>. We investigate thus here if thinning down the MoO<sub>x</sub> layer below 4 nm indeed enables this current-density gain. Furthermore, we explore in detail how MoO<sub>x</sub> thickness lower than 4 nm influences selectivity and passivation of devices using MoO<sub>x</sub> as a hole-selective layer.

## II. EXPERIMENTAL DETAILS

Five silicon heterojunction samples each consisting of five cells were fabricated following the same process sequence as described in [28], varying MoO<sub>x</sub> thickness between 0 nm (no MoO<sub>x</sub> layer) and 4 nm<sup>1</sup>. We used 195- $\mu$ m-thick n-type textured float zone wafers with a resistivity of 1.7-2.3  $\Omega$ cm. A stack composed of amorphous and microcrystalline ( $\mu$ c) hydrogenated silicon, (i)a-Si:H/(n)a-Si:H / (n) $\mu$ c-Si:H, was deposited at the back side by plasma enhanced chemical vapor deposition (PECVD) at 200 °C on all wafers. A layer of 6 nm of (i)a-Si:H was then deposited on the front side of the wafers. After removal of the surface oxide in an aqueous solution of 5% diluted hydrofluoric acid (HF), a 4-nm-, 3-nm-, 2-nm- or 1-nm-thick MoO<sub>x</sub> layer was thermally evaporated on the front side, while one sample did not receive MoO<sub>x</sub> (neither (p)a-Si:H layer). MoO<sub>x</sub> evaporation was done in a vacuum chamber (base pressure before deposition  $\sim 4 \times 10^{-6}$  mbar) from stoichiometric MoO<sub>3</sub> powder at a deposition rate of about 0.03 nm/s. Finally, indium tin oxide (ITO, 70 nm) was sputtered on the front through a mask to form the five 2 x 2 cm<sup>2</sup> devices per wafer. ITO (150 nm) and Ag (100 nm) were then sputtered over the full back side area. A silver grid was finally screen-printed on the front side using a low-temperature paste, cured at 130 °C in a belt furnace. Fig. 2 summarizes the process flow.

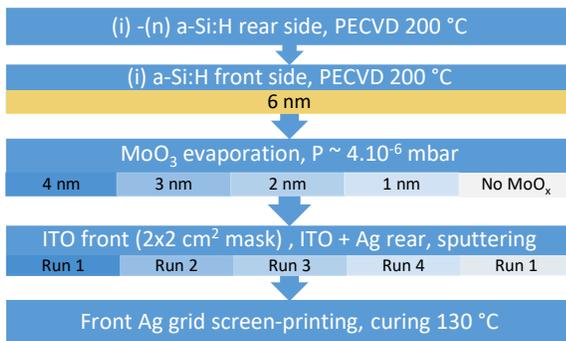


Fig. 2: Process flow of the different solar cells

The *J-V* characterization is performed with a Wacom WXS-90S-L2 solar simulator, under standard test condition (AM 1.5G, 100 mW/cm<sup>2</sup> at 25 °C). The cells are measured one by one, on the wafer through a mask hiding their edges and the rest of the wafer. The light spectrum intensity is calibrated every week through reference solar cell, over 315-800 nm, 650-1180 nm, and 315-1180 nm. Before each measurement, a reference solar cell is also used to adjust the calibration and normalize the current accordingly.

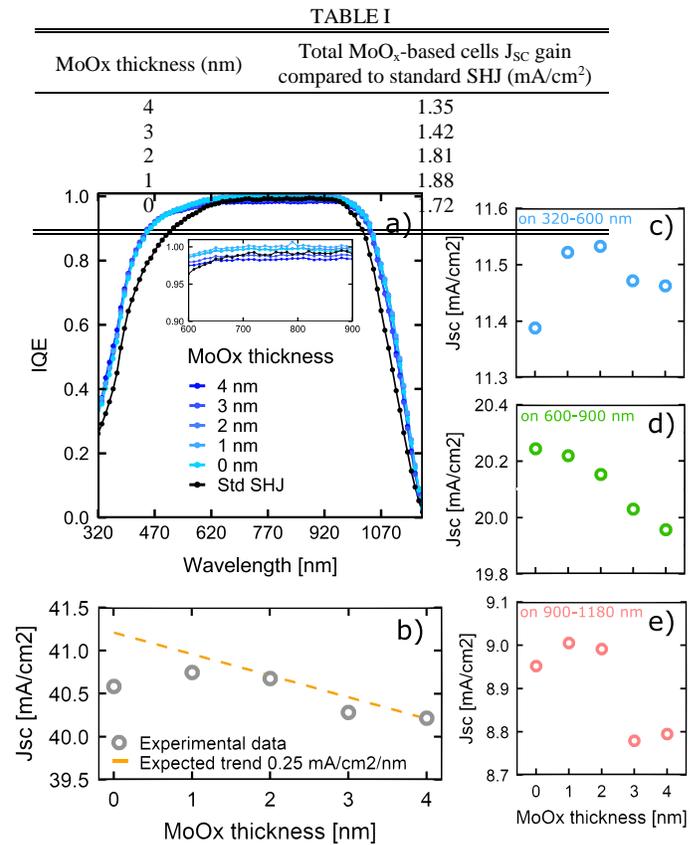
The external and internal quantum efficiency (EQE and IQE respectively) measurements are made utilizing in-house built setup, with a rectangular illumination beam which is 2 mm x 1

mm large. The measurement does not include finger shading, leading to a higher integrated current value compared to the one measured in *J-V* characterization. Lifetime measurements are performed with a Sinton Instrument WCT-120 by photoconductance decay in transient mode [29], [30]. For each wafer, measurement is performed at the five different solar cell location then averaged. Suns-Voc characterization are realized with a Sinton Instrument WCT-120 with an Illumination-Voltage tester stage.

## III. SHORT-CIRCUIT CURRENT DENSITY AND OPTICS ANALYSIS

Fig. 3.a) shows the IQE of all MoO<sub>x</sub>-based cells in addition to a standard SHJ cell reference processed in the same week, and Table 1 summarizes the MoO<sub>x</sub>-based cells short-circuit current density (*J*<sub>SC</sub>) gain compared to this reference.

The 4 nm-thick MoO<sub>x</sub> sample has a gain identical to the one



obtained in the previous experiment, confirming the robustness of this metric. *J*<sub>SC</sub> is increasing with thinner MoO<sub>x</sub>-layer samples, from 4-nm to 1-nm-thick MoO<sub>x</sub>. This increase partially originates from the reduced MoO<sub>x</sub> sub-bandgap parasitic absorption which occurs on the range 600 nm – 900 nm [28], as shown by the zoomed in plot on Fig. 3.a). It is completely evicted for devices with a MoO<sub>x</sub> layer thickness strictly below 3 nm since their IQE values on this range are above the ones of the reference SHJ cell. This demonstrates that there is still parasitic absorption even in an optimal MoO<sub>x</sub> layer

Fig. 3: a) IQE plots of the six different cells; b) current density evolution with MoO<sub>x</sub> thickness; c) d) e): the different spectral contribution to current density against MoO<sub>x</sub> thickness.

as thin as 4 nm, amounting to  $\sim (0.5) \pm 0.1$  mA/cm<sup>2</sup>. The trend reverses from 1 nm to 0 nm thick MoO<sub>x</sub> and this is also highlighted on Fig 3.b, where experimental  $J_{SC}$  extracted from EQE for all samples are plotted together with the expected trend of 0.25 mA/cm<sup>2</sup>/nm (calculated from our previous work with MoO<sub>x</sub> layer thinned from 9 nm to 4 nm). To identify the origin of this deviation, the  $J_{SC}$  contribution from three spectrum regions (320-600 nm, 600-900 nm, and 900-1180 nm) are displayed in Fig. 3.c), d) and e). The  $J_{SC}$  departure from the expected trend mostly originates from the wavelength range 320-600 nm (see Fig. 3 c)) and affects both the 0-nm and 1-nm-thick MoO<sub>x</sub> samples. On one hand, thinning down the ITO/MoO<sub>x</sub>-stack thickness is expected to shift the minimum of reflection to shorter wavelengths, thus to increase the EQE response in this range. On the other hand, a drop in front passivation would reduce at a point the  $J_{SC}$ , especially this short-wavelength range, since high front recombination will interfere with charge extraction. These two effects were simulated using PC1D to evaluate their expected magnitude. Thinning down the antireflective coating (ARC) by 4 nm increases  $J_{SC}$  on the 320-600 nm range by 0.4 mA/cm<sup>2</sup>, which is opposite to the observed deviation.

Conversely, increasing the front-surface recombination velocity from 10 cm/s (simulating a well-passivated surface for SHJ) to 10<sup>7</sup> cm/s (corresponding to a very poor surface passivation) resulted in a  $J_{SC}$  loss of 0.4 mA/cm<sup>2</sup> on this same wavelength range, which is consistent with the observed deviation. Although simplistic, these qualitative simulations correspond to the same order of magnitude of  $J_{SC}$  variation as the one we observed in our experiment, and suggest that the observed  $J_{SC}$  loss when using a too thin MoO<sub>x</sub> film can be attributed to passivation damage, which will be discussed in the following.

The small  $J_{SC}$  loss for the 0-nm-thick MoO<sub>x</sub> sample on the range 900-1180 nm (Fig. 3.e)) can be attributed to the aforementioned effect of minimum of reflection shift towards shorter wavelengths. An oxygen exchange from MoO<sub>x</sub> to ITO, decreasing the doping of the latter, would also mitigate the free carrier absorption responsible for parasitic absorption in the near infrared (IR) range and enhance the MoO<sub>x</sub>-based cells IR response in comparison with no MoO<sub>x</sub>-based layers.

#### IV. ELECTRICAL ANALYSIS

The extracted  $J$ - $V$  electrical parameters of the five devices (open circuit voltage ( $V_{OC}$ ),  $J_{SC}$ , fill factor ( $FF$ ), efficiency (Eff.)) are plotted in shades of blue in Fig. 4.a), b), c), d) respectively. In addition, data from the previous experiment (same process steps but MoO<sub>x</sub> thickness from 9 to 4 nm) are displayed with pink shades on the same graph [28]. Globally, the 4-nm-thick MoO<sub>x</sub>-based device of this new study has poorer performances (lower  $J_{SC}$  and  $FF$ ) compared to the previous processed one, which can be explained by two aspects. First, the lower  $FF$  and slightly lower  $V_{OC}$  originate from a poorer passivation from the very beginning in the process steps (see Fig. 5), due to slight mechanical damage during the cleaning process, as well as possible wafer-quality variability or (i)a-

Si:H batch-to-batch variability.  $FF$  is also slightly impacted by higher series resistance due to screen-printing issue for the front grid metallization. Nevertheless, the device employing a 4-nm-thick MoO<sub>x</sub> layer exhibits globally good performances compared to the thinner-MoO<sub>x</sub> devices.

From devices employing 9-nm-thick to 4-nm-thick MoO<sub>x</sub> films,  $V_{oc}$  upholds above 700 mV whereas it drops from the 3-nm-

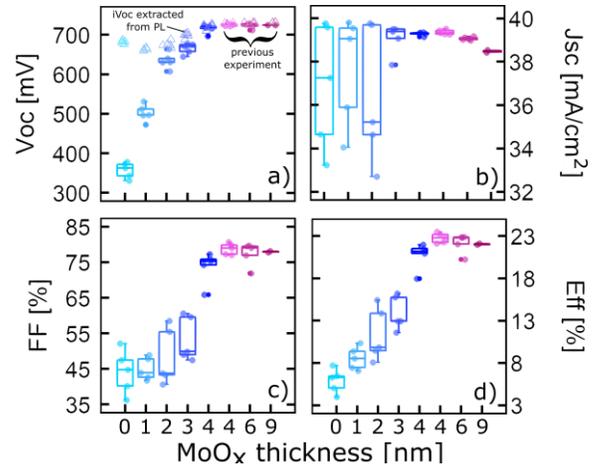


Fig. 4: a) b) c) d): electrical parameters extracted from the  $J$ - $V$  characteristics of the solar cells processed in this work and previous one [8]. The  $iV_{oc}$  values on graph a) are extracted from photoluminescence imaging on final solar cells structures (see below).

thick to 0-nm-thick MoO<sub>x</sub>-based samples, with an increasingly steep slope. The same behavior is observed for  $FF$ , with an even more drastic drop. To identify the influence of passivation and selectivity on these losses, we performed lifetime measurements, photoluminescence (PL) imaging, suns- $V_{oc}$  at high illumination, and  $J$ - $V$  curve fittings.

#### A. Lifetime-base passivation investigation

Fig. 5 shows the lifetime of the different samples after each process step, measured at a carrier injection of  $5 \times 10^{15}$  cm<sup>-3</sup> which is around the range of solar cells standard operating carrier densities). The measurement after ITO front deposition is done prior to the screen the printing and annealing of the contacts. Here again, data from the previous experiment is

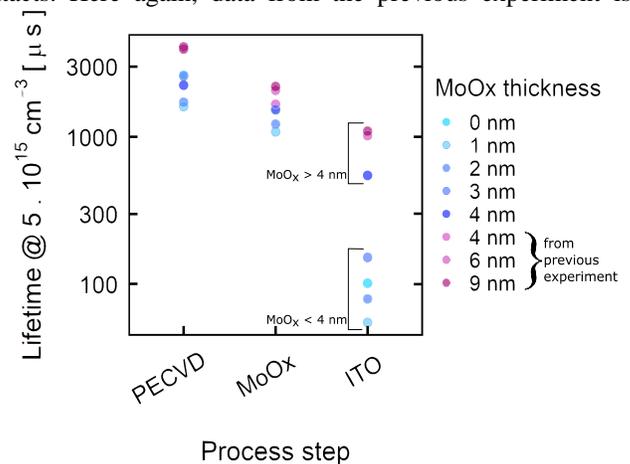


Fig. 5: Evolution of cells lifetime, taken at a carrier injection of  $5 \times 10^{15}$ /cm<sup>3</sup>, through the different process steps

added (pink shades). Highest-lifetime samples after PECVD remain the best after MoO<sub>x</sub> deposition, however an overall lifetime decrease is seen for all the samples after MoO<sub>x</sub> deposition. Such drop is common after deposition of hole-selective contacts (including (p)a-Si:H layers), and is attributed to the shift of the Fermi level in the (i)a-Si:H layer towards the valence band edge [31], [32]. After the ITO front sputtering, all samples experience a lifetime decrease, attributed to sputtering damage (the measurement was done prior to any curing), but devices from 9-nm-thick to 4-nm-thick in both experiments hold a lifetime around 1 ms whereas the lifetime of the devices with thinner MoO<sub>x</sub> films plunge down to 0.01-0.2 ms. Interestingly, the device with bare (i)a-Si:H maintains a lifetime superior to the devices having an additional 1-nm- or 2-nm-thick MoO<sub>x</sub> layer. This could be due to the higher initial lifetime, or to a stronger impact of the sputter-damage when a very thin MoO<sub>x</sub> film is present, presumably due to the aforementioned shifting of the Fermi-level closer to the valence band.

PL imaging of Fig. 6 gives a qualitative information about lifetime in the final device structure (the full area silver sputtering at the backside makes lifetime measurement by photoconductance decay impossible) after curing at 130 °C. It pictures the wafer with an injection equivalent to open circuit (OC) condition at one Sun. The PL intensity (arbitrary unit) is directly proportional to the radiative recombination rate, itself proportional to the  $n \times p$  ( $n$  being the electrons concentration,  $p$  the holes one). Here, PL images were normalized to a common scale. The five solar cells per wafer appear as squares, corresponding to the ITO-pad area. Around these squares, ITO is not present, but those surfaces still received the MoO<sub>x</sub>/(i)a-Si:H deposition. Scratches are visible on several images due to previously discussed mechanical damage during processing. The signal intensity for the 4-nm-thick MoO<sub>x</sub>-based solar cells (with ITO) remains almost as high or half high as the signal intensity around these cells (no ITO), whereas the contrast between the solar cells (low response) and their surrounding (high response) for devices which received less than 4-nm-thick MoO<sub>x</sub> is much stronger. The MoO<sub>x</sub> being too thin, it may not protect the (i)a-Si:H layer enough, irreversibly damaging the cell surface passivation even after curing. For a more quantitative analysis, we extracted the implied open circuit voltage  $iV_{OC}$  from our PL images, which can be deduced from the  $n \times p$  product [33], [34]. We calibrated the proportionality coefficient between the PL counts and  $n \times p$  by assuming that the lifetime in the areas not covered by ITO is similar to the lifetime prior to ITO deposition. We thus used

the  $iV_{OC}$  measured by photoconductance decay prior to ITO and Ag deposition as corresponding to the PL counts around the squared ITO-covered cells. The small differences in the front contact stack between samples are not expected to impact significantly the PL counts with respect to the passivation losses we observe.

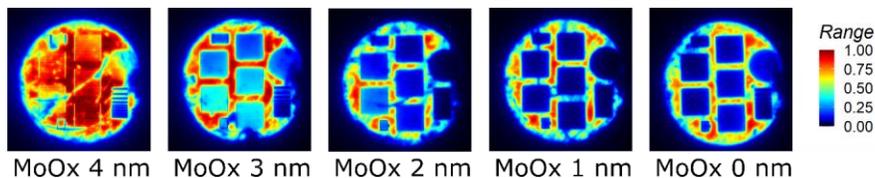


Fig. 6: PL imaging of the different cells, in open circuit conditions (1 Sun)

Fig. 4.a) shows the  $iV_{OC}$  of the final devices. It drops by around 70 mV between the 4-nm-MoO<sub>x</sub> sample and the 1-nm-MoO<sub>x</sub> sample, vouching for the expected passivation loss. Nevertheless, the difference between the measured external  $V_{OC}$  of the devices and their  $iV_{OC}$  (noted  $\Delta V_{OC} = iV_{OC} - V_{OC}$ ) increases when thinning down the MoO<sub>x</sub> layer, witnessing at a selectivity loss as well, in line with work from Bivour *et al.* [35].

### B. Selectivity probing

In light of the previous result, we probed the selectivity of our front hole contact for all the different MoO<sub>x</sub> layers thicknesses, through measurements and simulations.

#### 1) Suns- $V_{OC}$ measurements for recombination mechanism investigation and first selectivity study approach

We plotted illumination versus  $V_{OC}$ , also called “Suns- $V_{OC}$ ” analysis [30], [36], [37], of our best cell for each condition, from low (0.01 Suns) to high (135 Suns) illumination. In previous works, this kind of measurement at high illumination was demonstrated to highlight transport issues that can impact the cell selectivity, passivation and transport at one sun, [35], [37]. Notably, a deviation from the logarithmic  $V_{OC}$  increase with illumination was shown to be a signature of poorly selective hole contacts originating from the formation of a Schottky barrier due to work function misalignment. As depicted in Fig. 8, instead of stronger reversal in the curve appearing earlier and earlier as the MoO<sub>x</sub> layer is thinned down from 4 to 0 nm, like it was observed in [35] and [37] for cells with weaker contact quality, we noticed no difference in our cells response at high illumination. It hints that there is no reverse Schottky diode impeding carrier extraction, even for the thinnest MoO<sub>x</sub> layers. The green dashed and red dotted linear slopes are added to the plot as guide for the eyes, and

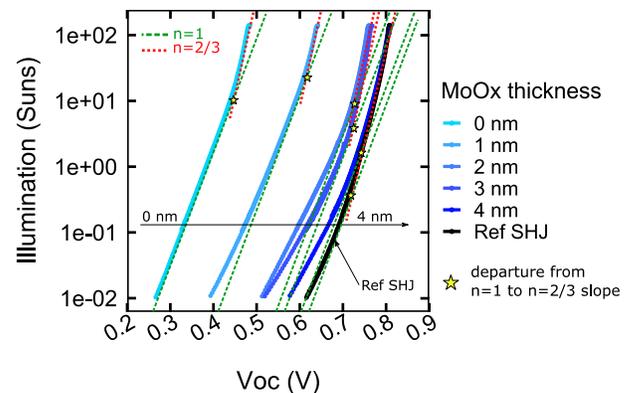


Fig. 8: Suns- $V_{OC}$  measurements of the different cells, on a wide illumination range (0.01 to 135 Suns)

correspond to the response of an ideal p-n junction case with an ideality factor of  $n = 1$  and  $n = 2/3$  respectively, following the

Shockley diode equation:  $J(V) = J_0 \left( e^{\frac{qV}{nkT}} - 1 \right)$ . The case  $n=1$  corresponds to the ideal diode case with radiative recombination only and no traps involved in the processes [38], [39]. The case  $n=2/3$  stands for a diode where Auger recombination is predominant [38], [40]. Globally, from 0.5 to 100 suns, all the cells follow these two regimes, switching from  $n=1$  to  $n=2/3$  at different illuminations according to the different  $\text{MoO}_x$  thicknesses. The cell with 4 nm of  $\text{MoO}_x$  works in high injection at an illumination a bit higher than 1 sun already (it changes regime from  $n=1$  to  $n=2/3$  at that illumination), which is typical of silicon heterojunction solar cells with good working contacts, whereas the cell with only 1 nm of  $\text{MoO}_x$  only reaches Auger regime around 20-sun illumination. This correlates well with the lifetime variations reported in Fig. 6 and 7, with higher-lifetime samples reaching Auger regime at lower illumination.

At lower illuminations (below 0.1 sun), so lower carrier injection,  $\text{MoO}_x$ -based cells show an ideality factor between 1 and 2, in general attributed to Shockley Read Hall recombination involving traps in the transport and recombination process [38], [39], [41]. Interestingly and contrary to the other samples, the cell without  $\text{MoO}_x$  (0 nm  $\text{MoO}_x$ ) keeps an ideality factor of  $n=1$  with a straight slope sticking to the ideal diode behavior. The same behavior is measured on a reference standard SHJ in a lower extent (see Fig. 8). This effect is unlikely linked to shunt resistance - which was not considered in the calculation-, since the calculation from dark  $J$ - $V$  curves showed they were all above  $1 \times 10^5 \Omega\text{cm}^2$ . It could either come from inhomogeneity of the  $\text{MoO}_x$  layer or even local pin-holes in this layer [42], or from a drop of passivation in low injection due to defects in a-Si:H following the shift of Fermi level closer to the valence band [31], [32]. These Suns- $V_{OC}$  measurements show that sub-optimal  $\text{MoO}_x$  thickness has a fundamentally different influence on selectivity compared to too-lightly doped (p)a-Si:H [35].

## 2) $J_{0s}$ fitting through Roe *et al.* modeling

To further understand the origin of the selectivity loss - and somehow the  $V_{OC}$  and  $FF$  drop - of our thin- $\text{MoO}_x$  contacts, we fitted our  $J$ - $V$  curves with the model of Roe *et al.* [43] which is adapted for contact-limited devices and relies on four partial currents (one for electrons and one for holes at each contact) as described in Fig. 9a. The current-voltage curve can be derived following equation (1), where  $J_L$  is the photogenerated density current,  $V_T$  the thermal voltage ( $k_B T/q$ ,  $k_B$  the Boltzmann constant,  $T$  the temperature and  $q$  the electronic charge).  $J_{0h}^{MoOx}$  and  $j_{0e}^{MoOx}$  stand for the hole and electron equilibrium exchange current densities at the hole  $\text{MoO}_x$ -based contact, and  $J_{0h}^{(n)aSiH}$  and  $J_{0e}^{(n)aSiH}$  stand for the hole and electron equilibrium exchange current densities at the (n)a-Si:H-based contact.  $R_S$  is an ohmic series resistance which we added to the original equation to account for non-contact related resistive losses (in the  $\text{MoO}_x$ , ITO, and Ag electrodes). In light of the previous results on shunt resistance, the latter was not considered in the equation. To reproduce the  $J$ - $V$  curves of samples with various  $\text{MoO}_x$ -layer thicknesses, we varied  $J_{0h}^{MoOx}$ ,  $j_{0e}^{MoOx}$ ,  $J_{0e}^{(n)aSiH}$ ,  $J_{0h}^{(n)aSiH}$ , and  $R_S$ . This modelling thus does not rely on specific materials properties (work functions, barriers height, nature of carrier transport) as inputs. The experimental  $J$ - $V$  curves and the fitted ones are plotted on Fig. 9.b). The disagreement between experimental and simulated data around the rectifying region of the JV curves for cells from 3-nm to 1-nm-thick  $\text{MoO}_x$  can tentatively be attributed to micro-shunts which could impact the  $FF$  [44], [45], strong passivation damages that occurred during the cleaning step, or to the aforementioned screen-printing issue.

$$J(V) = -\left( J_L + j_{0e}^{MoOx} + J_{0h}^{(n)aSiH} \right) + \frac{J_L + j_{0e}^{MoOx} + J_{0e}^{(n)aSiH}}{1 + \frac{j_{0e}^{MoOx}}{J_{0e}^{(n)aSiH}} e^{-\frac{V-R_S J}{V_T}}} + \frac{J_L + j_{0h}^{(n)aSiH} + J_{0h}^{MoOx}}{1 + \frac{j_{0h}^{MoOx}}{J_{0h}^{(n)aSiH}} e^{-\frac{V-R_S J}{V_T}}} \quad (1)$$

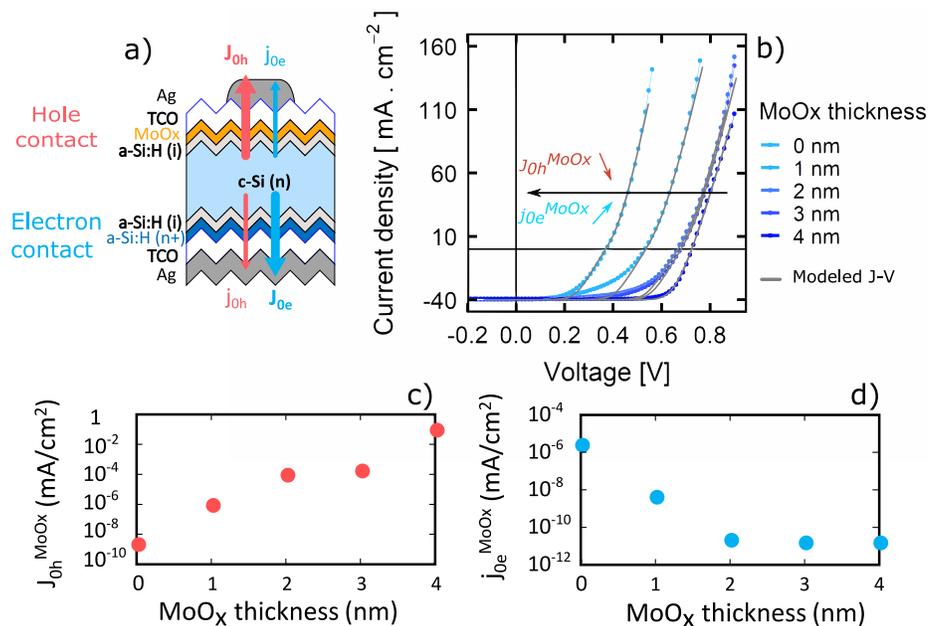


Fig. 9: a) schematic representation of the four different current density involved in Roe *et al.* model; b)  $J$ - $V$  experimental (shades of blue) curves and their fitted data (shades of yellow); c) and d) evolution of  $j_{oe}^{MoOx}$  and  $J_{oh}^{MoOx}$  with  $\text{MoO}_x$  layer thickness.

For all MoO<sub>x</sub> thicknesses,  $J_{0e}^{(n)aSiH}$  and  $J_{0h}^{(n)aSiH}$  barely varied around 10<sup>3</sup> mA/cm<sup>2</sup> and 1.3 × 10<sup>-14</sup> mA/cm<sup>2</sup> respectively, while  $J_{0h}^{MoOx}$  decreased in a quasi-exponential way (see Fig. 9.c)), from 1 mA/cm<sup>2</sup> to 4 × 10<sup>-9</sup> mA/cm<sup>2</sup>, with MoO<sub>x</sub> thickness decrease. On the contrary,  $J_{0e}^{MoOx}$  increased from 1.8 × 10<sup>-11</sup> to 3 × 10<sup>-6</sup> mA/cm<sup>2</sup> for MoO<sub>x</sub> below 2 nm.

The shunt resistance was kept constant at 10 kΩ·cm<sup>2</sup>, and the series resistance decreased from 1.3 to 0.85 Ω·cm<sup>2</sup>. Still, we can observe that the selectivity loss is caused by a worsening of both the electron-blocking ( $J_{0e}^{MoOx}$  increase) and hole-collecting ( $J_{0h}^{MoOx}$  decrease) ability of the contact.

### 3) In situ hole contact work function estimation

A qualitative analysis of band diagrams (Fig. 10) hints that aforesaid loss could come from a reduction of MoO<sub>x</sub> work function. Besides, a work function decrease affecting MoO<sub>x</sub> was often reported in literature [46], [47], and Greiner *et al.* notably reported that MoO<sub>x</sub> work function is diminished near interfaces due to chemical and physical reactions with the substrate material it grows on [48]. Accordingly, under a critical thickness, MoO<sub>x</sub> work function is affected over the whole layer. In our case, an oxygen/hydrogen exchange could occur at the (i)a-Si:H/MoO<sub>x</sub> interface [46], [49] and provoke MoO<sub>x</sub> chemical reduction, decreasing its work function. At the ITO/MoO<sub>x</sub> interface, oxygen exchange (thermodynamically possible) or reduction through charge transfer due to work function misalignment could also occur [48].

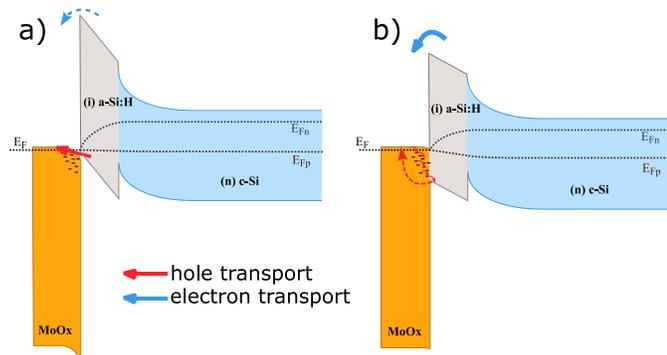


Fig. 10: Qualitative band diagram scheme of the hole contact for a MoO<sub>x</sub>-based SHJ under illumination and at open circuit, with a) a high work function and b) a low work function.  $E_{Fn}$  and  $E_{Fp}$  are the quasi Fermi levels for electrons and holes respectively.

Fig. 10 exhibits our MoO<sub>x</sub>-based hole contact band diagram, for a MoO<sub>x</sub> with a high (a.) and low (b.) work function. We added a simplified carrier transport, schematized by the blue and red arrows. In case of a high work function, hole (red arrow) transfer from the (i)a-Si:H valence band to the MoO<sub>x</sub> conduction band is possible through band to band tunneling or trap assisted tunneling [50] (more correctly - but equivalently - electrons coming from ITO and MoO<sub>x</sub> recombines with holes at the MoO<sub>x</sub>/(i)a-Si:H interface), whereas parasitic electrons (blue arrow) face a high energetic barrier due to band bending. In case of a lower work function, the misalignment between the MoO<sub>x</sub> conduction band and the (i)a-Si:H valence band forces transport through trap assisted tunneling which reduces the extraction efficiency. Simultaneously, the energetic barriers preventing electrons to pass is also lowered, enhancing parasitic

electron thermionic emission and unintended recombination. This behavior is consistent with the trends observed for carrier density currents extracted from the Roe *et al.* modelling.

In a simple approach, assuming parasitic electrons at hole contact travel through thermionic emission, we can calculate the barrier height  $\phi_b$ , the energy difference between the Fermi level at the interface with (n)c-Si and the (i)a-Si:H conduction band maximum, thanks to the electron current density  $j_{0e}^{MoOx}$  we found with the Roe *et al.* model and using the thermionic emission equation (2) [51]:

$$j_{0e} = A^* T^2 e^{-\frac{\phi_b}{qV_T}} \quad (2)$$

with  $A^*$  the effective Richardson constant and  $T$  the temperature. With an analysis in temperature from 0 °C to 70

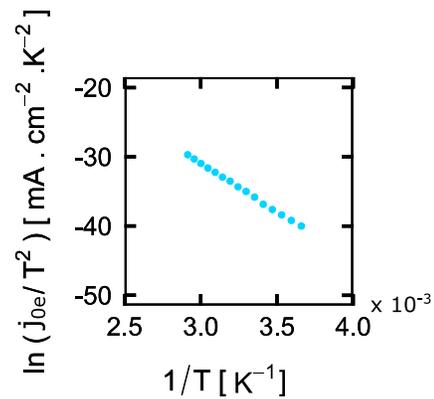


Fig. 11: Plot of  $\ln(j_{0e}^{MoOx}/T^2)$  as a function of  $1/T$ , over 0 °C to 70 °C. Linearity of the plot proves the thermionic emission nature of electron transport. The different  $j_{0e}^{MoOx}$  were extracted from a MoO<sub>x</sub>-based cell experimental  $J$ - $V$  fitting with Roe *et al.* modeling.

°C, we confirmed that the electron current passing through the hole contact indeed follows this law (see Fig. 11). Following thermionic emission mechanism, decreasing the barrier height

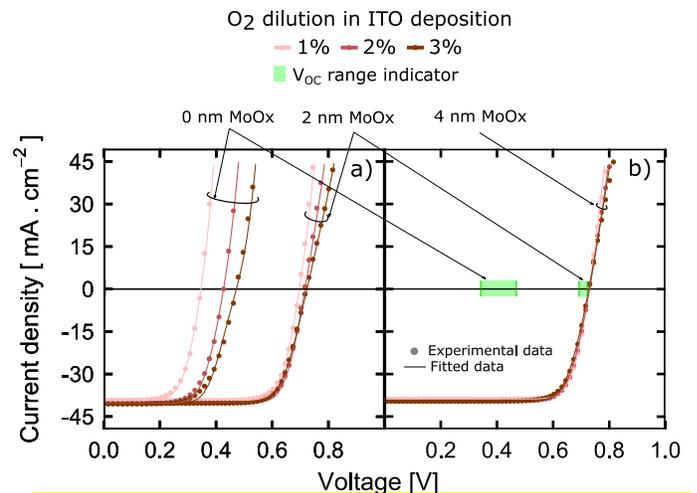


Fig. 12:  $J$ - $V$  experimental and fitted curves of solar cells with 0 nm, 2 nm and 4 nm of MoO<sub>x</sub>, with three different ITO oxygen doping each. For more clarity, solar cells with 0 and 2 nm of MoO<sub>x</sub> are plotted on graph a), and 4-nm-MoO<sub>x</sub> thick cells are plotted on graph b) with 0-nm and 2-nm  $V_{0c}$  range added for comparison.

provokes thermionic current increase. Here, according to Fig. 9.d, parasitic thermionic electron current is increasing with decreasing MoO<sub>x</sub> thickness, so the barrier height blocking electrons might indeed reduce - and so is the MoO<sub>x</sub> work

function - as MoO<sub>x</sub> thickness reduces. We did not model  $J_{0h}^{MoOx}$  due to complexity involved in trap or multi-trap assisted tunneling mechanisms, and to the lack of information linking  $J$  and the energy barriers in such transport. Yet, fitting of the parasitic electron current can be used to estimate the hole contact work function through calculation of  $\phi_b$ . Fig. 9.d indicates that above 2 nm of MoO<sub>x</sub>,  $j_{0e}^{MoOx}$  is plateauing even though  $J_{0h}^{MoOx}$  is still varying. This mean that our work function estimation with  $j_{0e}^{MoOx}$  will also saturate for MoO<sub>x</sub> layers above 2 nm, which might be physically incorrect as  $J_{0h}^{MoOx}$  still increases from 2 nm to 4 nm.

To verify this hypothesis, and to get more accurate fitted data to properly estimate hole contact work function, we processed new MoO<sub>x</sub>-based solar cells with 0 nm, 2 nm and 4 nm MoO<sub>x</sub> layers, each coated with ITOs of three different doping obtained by varying the oxygen dilution in Ar during sputtering deposition. Hall effect measurements gave bulk concentrations of  $4.10^{20} \text{ cm}^{-3}$ ,  $1.10^{20} \text{ cm}^{-3}$  and  $3.10^{19} \text{ cm}^{-3}$  for an oxygen dilution of 1%, 2 % and 3 % respectively. Fig. 12 illustrates the obtained  $J$ - $V$  curves, with both experimental (symbols) and fitted (lines) data. Compared to the previous series, we observe the same trend for  $V_{OC}$ , with lower  $V_{OC}$  for thinner MoO<sub>x</sub> thickness. Comparing now the influence of ITO doping, there is a strong impact when ITO is directly in contact with (i)aSi:H (0 nm of MoO<sub>x</sub>) as it constitutes the selective layer in this case (which is not very selective considering the poor  $V_{OCs}$ ). As expected, the less doped ITO – so the highest work function one – is the one giving the highest  $V_{OC}$ . Applying 2 nm of MoO<sub>x</sub> already efficiently screens the ITO influence as the  $V_{OC}$  spread is much narrower (Fig. 12.a and b.), and highly enhance selectivity with a  $V_{OC}$  gain of around 300 mV compared to the cells with ITO only. With 4 nm of MoO<sub>x</sub>, ITO influence seems completely screened and  $V_{OC}$  still slightly improved compared to 2-nm-MoO<sub>x</sub>-based cells. These results highlight that even though  $j_{0e}^{MoOx}$  is similar for 4 nm or 2 nm thick MoO<sub>x</sub>, work function of 2 nm MoO<sub>x</sub> layer in this contact stack is not high enough to screen the ITO work function mismatch influence on carrier extraction, contrary to a 4 nm MoO<sub>x</sub> layer.

With the approach developed in the previous paragraph, we can use thermionic emission law to extract the barrier height, and quantitatively estimate the hole contact work function of this new set of data which match the simulations. For all solar cells, we set  $A^* = 70 \text{ A/cm}^2 \cdot \text{K}^2$  assuming  $A^*$  for a-Si is close to those of c-Si [52], and approximates this value for p-type c-Si [51]. Assuming that the cells work in low to moderate injection under one sun, what is suggested by Suns- $V_{OC}$  measurements, and that there is a Fermi level pinning at the interface MoO<sub>x</sub>/(i)a-Si:H, we can suppose that  $\phi_b$  also represents the barrier height between MoO<sub>x</sub> Fermi level and (i)a-Si:H conduction band. Using 3.9 eV for a-Si:H electron affinity ( $E_A$ ) [53][54], we can extract MoO<sub>x</sub> work function (WF), so that:  $WF^{MoOx} = \phi_b + E_A^{aSi:H}$ . The calculated work function values range therefore from 4.6 eV to 4.8 for the cells with no MoO<sub>x</sub> layer, and around 5 eV for MoO<sub>x</sub> layers of 2 nm and 4 nm. The similar work function found for both 2 nm and 4 nm MoO<sub>x</sub> originates from the aforementioned limitation of extracting WF through  $j_{0e}^{MoOx}$ , but must be different according to results of Fig. 12 experiment. The low values obtained compared to literature (typically around 6.5 eV [23], [48]) suggest that even the thickest

investigated MoO<sub>x</sub> film is already strongly reduced. This can be expected since it is exposed to air between process steps (work function easily reduced by 1 eV [23], [55] [56]), and is sandwiched between two lower-work function layers prone to oxidation (thermodynamically and electronically [48], [56]), and significant sub-gap absorption is observed optically for a-Si:H/MoO<sub>x</sub>/ITO stacks [49]. This low value could also be understood as our calculated WF is an effective WF of the entire hole contact stack ITO/MoO<sub>x</sub>/(i)a-Si:H/(n)c-Si (still with MoO<sub>x</sub> WF playing a central role in the thermionic emission). Note that in the 0 nm MoO<sub>x</sub> case, corresponding to direct contact of (i)a-Si:H with ITO, the obtained values are in agreement with the range of 4.5 eV to 5.1 eV found in literature [57]–[59]. This mid-gap position correlates well with our obtained  $V_{OC}$  value around 350 mV (see Fig. 4.a and 12)) and the one found in literature for such TCO work function on n-type c-Si [60], [61], corresponding to the absence of any selectivity at the hole contact. It suggests that this methodology coupling  $J_{0s}$  with energy barriers and band diagram theory could be a valuable approach to characterize the work function of electrodes in use within the solar cells contact stack.

## V. CONCLUSION

In this work, we showed that an appreciable short circuit current gain is still possible when decreasing MoO<sub>x</sub> thickness from 4 nm to 1 nm, but at the cost of a severe degradation of  $FF$  and  $V_{OC}$ . The latter is due to both surface passivation and mainly selectivity loss, caused by a too thin protection against ITO sputtering and a probable reduction of the MoO<sub>x</sub> work function respectively. Below 1 nm of MoO<sub>x</sub>, we also discovered that the  $J_{SC}$  value was limited by the strong surface passivation damage. All these results are supported by lifetime, Suns- $V_{OC}$ , and PL measurements, calculations and simulations via PC1D and a model proposed by Roe *et al.* [43]. We experimentally demonstrate that MoO<sub>x</sub> optimal thickness appears to be 4 nm, a figure in agreement with Mazzarella *et al* work [62]. We also highlight that the parasitic electron current at the hole contact is not increasing from 4 nm to 2 nm, whereas the majority hole current is decreasing already.

This work overall showed that MoO<sub>x</sub> shows limitations to fabricate very-high-efficiency silicon heterojunction solar cells. However, further investigations could still be made, for instance using alternative TCO material (and/or deposition technique), or careful tuning of the passivation material and its interface with MoO<sub>x</sub> are particularly relevant routes [62].

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